# 74LVC125A

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

Rev. 7 — 11 April 2013

Product data sheet

# 1. General description

The 74LVC125A consists of four non-inverting buffers/line drivers with 3-state outputs (nY) that are controlled by the output enable input (nOE). A HIGH at nOE causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs.

### 2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



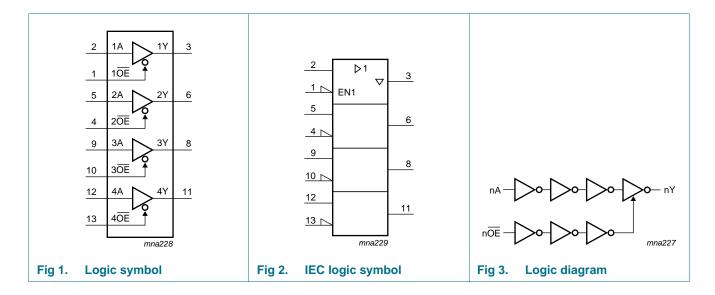
## Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

# 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC125AD	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm; body thickness 1.47 mm	SOT108-1
74LVC125ADB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1
74LVC125APW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74LVC125ABQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5\times3\times0.85$ mm	SOT762-1

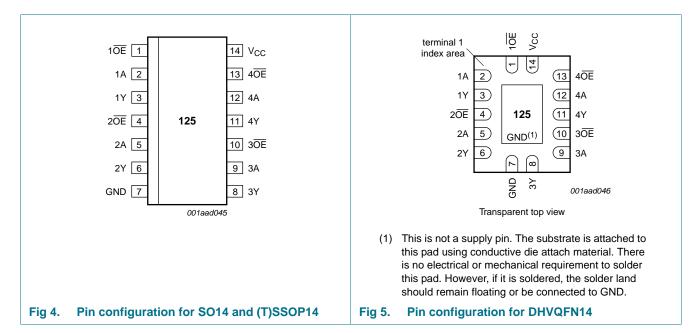
# 4. Functional diagram



### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

# 5. Pinning information

#### 5.1 Pinning



### 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1 <del>OE</del> , 2 <del>OE</del> , 3 <del>OE</del> , 4 <del>OE</del>	1, 4, 10, 13	data enable input (active LOW)
1A, 2A, 3A, 4A	2, 5, 9, 12	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V <sub>CC</sub>	14	supply voltage

# 6. Functional description

Table 3. Function selection[1]

Inputs nOE		Output
nOE	nA	nY
L	L	L
L	Н	Н
Н	X	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state

### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	$V_I < 0 V$	-50	-	mA
VI	input voltage		[ <u>1]</u> -0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
Vo	output voltage	output HIGH or LOW-state	[2] -0.5	$V_{CC} + 0.5$	V
		output 3-state	[2] -0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[3] _	500	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	$V_{CC}$	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and	V <sub>CC</sub> = 2.3 V to 2.7 V	0	-	20	ns/V
	fall rate	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SO14 packages: above 70 °C derate linearly with 8 mW/K.
For (T)SSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.
For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

## Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

# 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

$V_{IH} \qquad \begin{array}{l} \text{HIGH-level} \\ \text{input voltage} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.2 \ \text{V} \\ V_{CC} = 1.65 \ \text{V to } 1.95 \ \text{V} \\ V_{CC} = 2.3 \ \text{V to } 2.7 \ \text{V} \\ V_{CC} = 2.7 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.2 \ \text{V} \\ V_{CC} = 1.2 \ \text{V} \\ V_{CC} = 1.65 \ \text{V to } 1.95 \ \text{V} \\ V_{CC} = 2.3 \ \text{V to } 2.7 \ \text{V} \\ V_{CC} = 2.3 \ \text{V to } 2.7 \ \text{V} \\ V_{CC} = 2.7 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array} \qquad \begin{array}{l} V_{CC} = 1.65 \ \text{V to } 3.6 \ \text{V} \\ \end{array}$	V	Min 1.08 0.65 × V <sub>CC</sub> 1.7 2.0 V <sub>CC</sub> - 0.2	Typ[1]	Max 0.12 0.35 × V <sub>CC</sub> 0.7 0.8	Min 1.08 0.65 × V <sub>CC</sub> 1.7 2.0 - - -	Max 0.12 0.35 × V <sub>CC</sub> 0.7	V V V V V V V V
$\begin{array}{c} \text{input voltage} & V_{CC} = 1.65 \ \text{V to } 1.95 \ \text{V} \\ V_{CC} = 2.3 \ \text{V to } 2.7 \ \text{V} \\ V_{CC} = 2.7 \ \text{V to } 3.6 \ \text{V} \\ \end{array}$	V	0.65 × V <sub>CC</sub> 1.7 2.0	- - - -	- 0.12 0.35 × V <sub>CC</sub> 0.7	0.65 × V <sub>CC</sub> 1.7 2.0	- 0.12 0.35 × V <sub>CC</sub>	V V V V
$\begin{array}{c} V_{CC} = 1.03 \text{ V to } 1.93 \text{ V} \\ V_{CC} = 2.3 \text{ V to } 2.7 \text{ V} \\ V_{CC} = 2.7 \text{ V to } 3.6 \text{ V} \\ \end{array}$	V	1.7 2.0 - - -	- - - -	- 0.12 0.35 × V <sub>CC</sub> 0.7	1.7 2.0	- 0.12 0.35 × V <sub>CC</sub>	V V V
$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ $V_{IL} \qquad \text{LOW-level input voltage} \qquad V_{CC} = 1.2 \text{ V}$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ $V_{OH} \qquad \text{HIGH-level output voltage} \qquad V_{I} = V_{IH} \text{ or } V_{IL}$ $I_{O} = -100  \mu\text{A;}$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$ $I_{O} = -4 \text{ mA; } V_{CC} = 1 \text{ mA; } V_{CC} =$	V	2.0 - - - -	- - -	$0.12$ $0.35 \times V_{CC}$ $0.7$	2.0	$0.12$ $0.35 \times V_{CC}$	V V
$\begin{array}{c c} V_{IL} & LOW\text{-level input} \\ voltage & V_{CC} = 1.2 \ V \\ \hline V_{CC} = 1.65 \ V \ to \ 1.95 \ V \\ \hline V_{CC} = 2.3 \ V \ to \ 2.7 \ V \\ \hline V_{CC} = 2.7 \ V \ to \ 3.6 \ V \\ \hline V_{OH} & HIGH\text{-level} \\ output \ voltage & V_{I} = V_{IH} \ or \ V_{IL} \\ \hline I_{O} = -100 \ \mu A; \\ V_{CC} = 1.65 \ V \ to \ 3.6 \\ \hline I_{O} = -4 \ mA; \ V_{CC} = 1.65 \ V \ to \ 3.6 \\ \hline \end{array}$	V	- - -	- - -	$0.12$ $0.35 \times V_{CC}$ $0.7$	-	$0.12$ $0.35 \times V_{CC}$	V V
$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ $V_{OH} \qquad \begin{array}{l} \text{HIGH-level} \\ \text{output voltage} \end{array} \qquad \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL} \\ I_{O} = -100  \mu\text{A;} \\ V_{CC} = 1.65 \text{ V to } 3.6 \\ I_{O} = -4 \text{ mA; } V_{CC} = 1.65 \text{ V to } 3.6 \\ \end{array}$	V	- - - - V <sub>CC</sub> – 0.2	-	$0.35 \times V_{CC}$ $0.7$	- - -	$0.35 \times V_{CC}$	V
$V_{CC} = 2.3 \text{ V to } 1.93 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ $V_{OH} \qquad \text{HIGH-level} \qquad V_{I} = V_{IH} \text{ or } V_{IL}$ $I_{O} = -100  \mu\text{A};$ $V_{CC} = 1.65 \text{ V to } 3.6$ $I_{O} = -4 \text{ mA}; V_{CC} = 1$	V	- - - V <sub>CC</sub> – 0.2	-	0.7	- - -		
$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ $V_{OH} \qquad \begin{array}{l} \text{HIGH-level} \\ \text{output voltage} \end{array} \qquad \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL} \\ I_{O} = -100  \mu\text{A;} \\ V_{CC} = 1.65 \text{ V to } 3.6 \\ \hline I_{O} = -4 \text{ mA; } V_{CC} = 1.65 \text{ V to } 3.6 \\ \end{array}$		- - V <sub>CC</sub> – 0.2	-		-	0.7	V
$\begin{array}{c} V_{OH} & \text{HIGH-level} \\ \text{output voltage} & \hline \\ I_{O} = -100 \; \mu\text{A;} \\ V_{CC} = 1.65 \; V \; to \; 3.6 \\ \hline \\ I_{O} = -4 \; \text{mA;} \; V_{CC} = 1 \end{array}$		- V <sub>CC</sub> - 0.2		0.8	-		
output voltage $I_O = -100 \; \mu A;$ $V_{CC} = 1.65 \; V \; to \; 3.6$ $I_O = -4 \; mA; \; V_{CC} = 1$		V <sub>CC</sub> - 0.2				8.0	V
$V_{CC} = 1.65 \text{ V to } 3.6$ $I_{O} = -4 \text{ mA; } V_{CC} = 1$		$V_{CC}-0.2$					
	1.65 V		-	-	V <sub>CC</sub> – 0.3	-	V
I 0 m 1 1 / 2		1.2	-	-	1.05	-	V
$I_{O} = -8 \text{ mA}; V_{CC} = 2$	2.3 V	1.8	-	-	1.65	-	V
$I_O = -12$ mA; $V_{CC} =$	2.7 V	2.2	-	-	2.05	-	V
$I_{O} = -18 \text{ mA}; V_{CC} =$	3.0 V	2.4	-	-	2.25	-	V
$I_O = -24$ mA; $V_{CC} =$	3.0 V	2.2	-	-	2.0	-	V
$V_{OL}$ LOW-level $V_{I} = V_{IH}$ or $V_{IL}$							
output voltage $I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6$	V	-	-	0.2	-	0.3	V
$I_{O} = 4 \text{ mA}; V_{CC} = 1.0$	65 V	-	-	0.45	-	0.65	V
$I_{O} = 8 \text{ mA}; V_{CC} = 2.3$	3 V	-	-	0.6	-	8.0	V
$I_{O} = 12 \text{ mA}; V_{CC} = 2$	2.7 V	-	-	0.4	-	0.6	V
$I_{O} = 24 \text{ mA}; V_{CC} = 3$	3.0 V	-	-	0.55	-	0.8	V
$I_I$ input leakage $V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V}$ current	v or GND	-	±0.1	±5	-	±20	μА
$I_{OZ}$ OFF-state $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 3$ output current $V_O = 5.5$ V or GND	3.6 V;	-	±0.1	±5	-	±20	μΑ
$I_{OFF}$ power-off $V_{CC} = 0.0 \text{ V}; V_{I} \text{ or } V_{O} = 0.0 \text{ V}$	= 5.5 V	-	±0.1	±10	-	±20	μΑ
$I_{CC}$ supply current $V_{CC} = 3.6 \text{ V}; V_I = V_{CC}$ $I_O = 0 \text{ A}$	or GND;	-	0.1	10	-	40	μА
$\begin{array}{ll} \Delta I_{CC} & \text{additional} & \text{per input pin; V}_{I} = V_{CC} \\ & \text{supply current} & I_{O} = 0 \text{ A; V}_{CC} = 2.7 \text{ V t} \end{array}$		-	5	500	-	5000	μΑ
$C_I$ input $V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ capacitance $V_I = \text{GND to } V_{CC}$		-	4.0	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

# 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nA to nY; see Figure 6	[2]						
		$V_{CC} = 1.2 \text{ V}$		-	12.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	5.4	11.0	1.5	12.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.9	5.7	1.0	6.7	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	2.8	5.5	1.5	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.5	4.8	1.0	6.0	ns
t <sub>en</sub>	enable time	nOE to nY; see Figure 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	16.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	5.0	12.2	1.0	14.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.9	6.8	0.5	7.9	ns
	$V_{CC} = 2.7 \text{ V}$		1.5	3.1	6.6	1.5	8.5	ns	
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.3	5.4	1.0	7.0	ns
t <sub>dis</sub>	disable time	nOE to nY; see Figure 7	[2]						
		$V_{CC} = 1.2 \text{ V}$		-	7.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.2	4.6	7.5	2.2	8.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.6	4.2	0.5	5.0	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.1	5.0	1.5	6.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.2	4.6	1.0	6.0	ns
t <sub>sk(o)</sub>	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
$C_{PD}$	power dissipation	per buffer; $V_I = GND$ to $V_{CC}$	[4]						
	capacitance	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	6.0	-	-	-	pF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	9.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	12.4	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

$$P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o) \text{ where:}$$

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

 $C_L$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

ten is the same as tPZL and tPZH.

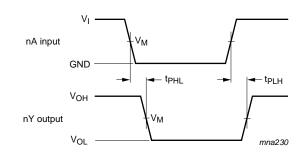
 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

<sup>[3]</sup> Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

<sup>[4]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

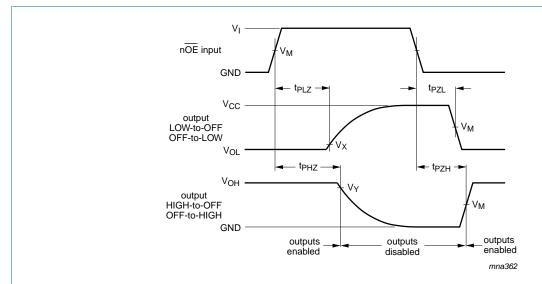
## 11. AC waveforms



Measurement points are given in Table 8.

 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 6. The input nA to output nY propagation delays



Measurement points are given in <u>Table 8</u>.

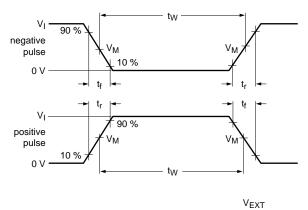
 $\ensuremath{V_{OL}}$  and  $\ensuremath{V_{OH}}$  are typical output voltage levels that occur with the output load.

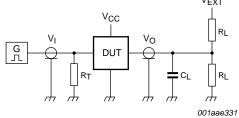
Fig 7. 3-state enable and disable times

Table 8. Measurement points

Supply voltage	Input		Output
V <sub>CC</sub>	V <sub>I</sub>	V <sub>M</sub>	V <sub>M</sub>
1.2 V	V <sub>CC</sub>	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
1.65 V to 1.95 V	V <sub>CC</sub>	$0.5 \times V_{CC}$	0.5 × V <sub>CC</sub>
2.3 V to 2.7 V	V <sub>CC</sub>	$0.5 \times V_{CC}$	0.5 × V <sub>CC</sub>
2.7 V	2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V

## Quad buffer/line driver with 5 V tolerant input/outputs; 3-state





Test data is given in Table 9.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

V<sub>EXT</sub> = External voltage for measuring switching times.

Fig 8. Test circuit for measuring switching times

Table 9. Test data

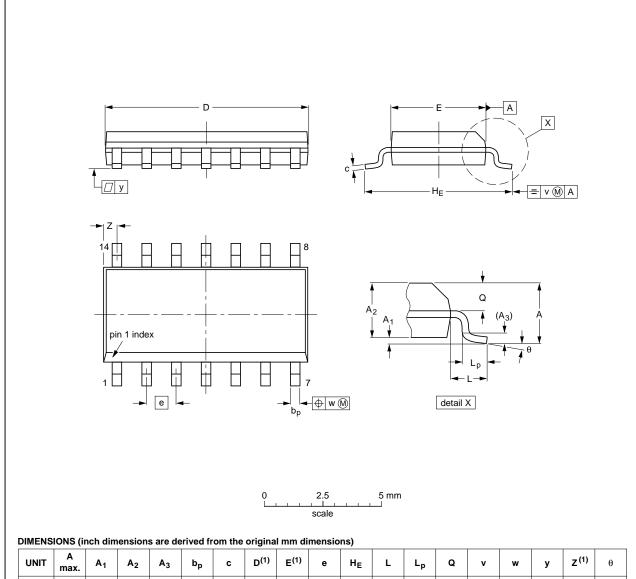
Supply voltage	Input		Load		V <sub>EXT</sub>	V <sub>EXT</sub>				
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	$R_L$	t <sub>PLH</sub> , t <sub>PHL</sub>	$t_{PLZ}, t_{PZL}$	$t_{PHZ}$ , $t_{PZH}$			
1.2 V	$V_{CC}$	≤ 2 ns	30 pF	1 k $\Omega$	open	$2\times V_{CC}$	GND			
1.65 V to 1.95 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND			
2.3 V to 2.7 V	$V_{CC}$	≤ 2 ns	30 pF	$500 \Omega$	open	$2\times V_{CC}$	GND			
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND			
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND			

### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

# 12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

		ENCES	EUROPEAN	ISSUE DATE
IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
076E06	MS-012			<del>99-12-27</del> 03-02-19
-		IEC JEDEC	IEC JEDEC JEITA	IEC JEDEC JEITA PROJECTION

Fig 9. Package outline SOT108-1 (SO14)

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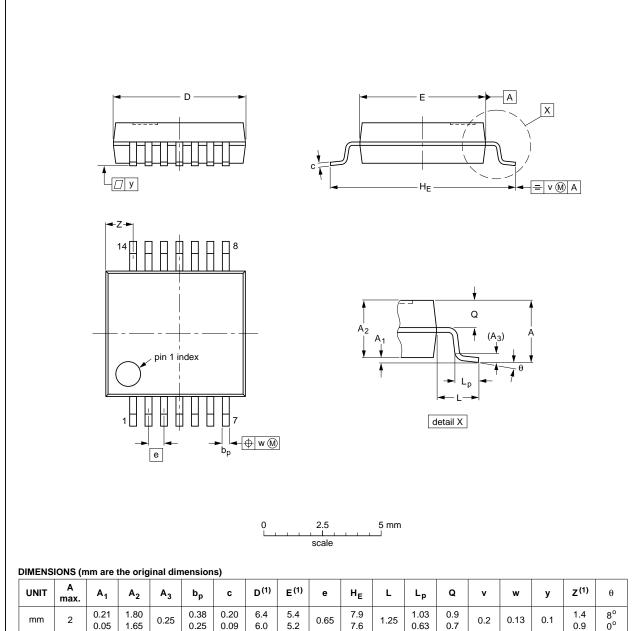
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## Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	ø	v	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	IOOUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT337-1		MO-150				<del>-99-12-27</del> 03-02-19	

Fig 10. Package outline SOT337-1 (SSOP14)

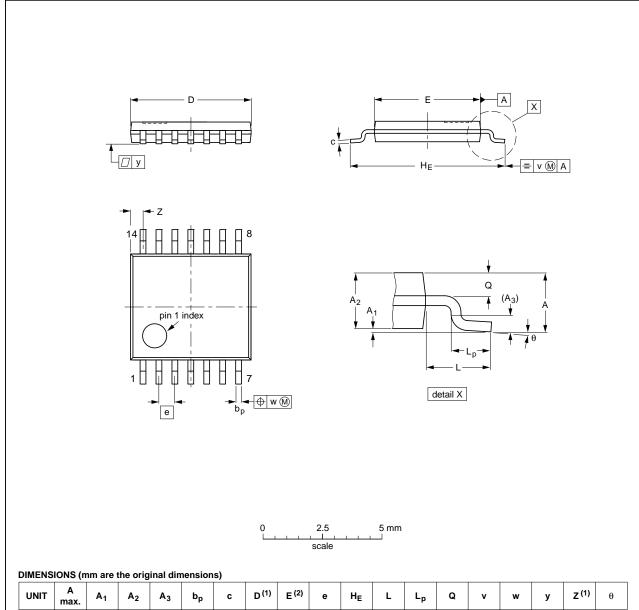
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### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



						-,												
UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	1550E DATE	
SOT402-1		MO-153				<del>99-12-27</del> 03-02-18	

Fig 11. Package outline SOT402-1 (TSSOP14)

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### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

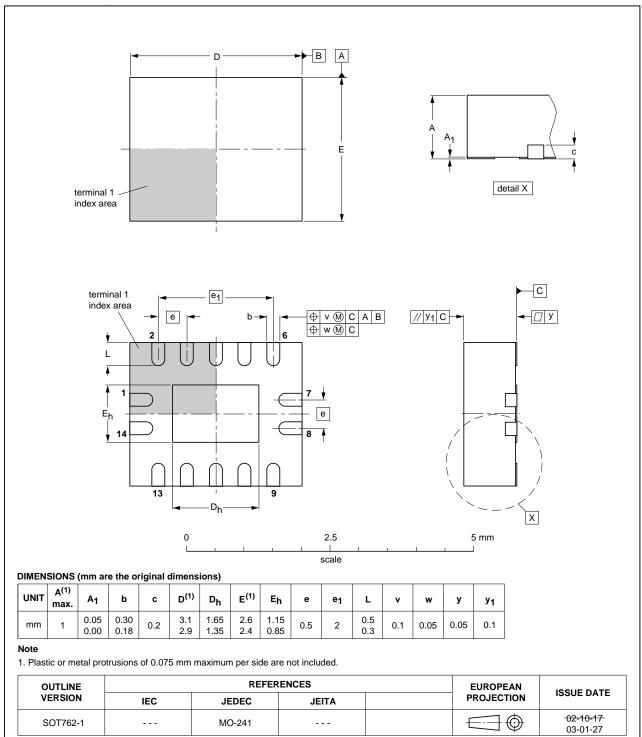


Fig 12. Package outline SOT762-1 (DHVQFN14)

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## Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

# 13. Abbreviations

#### Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
MM	Machine Model
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

# 14. Revision history

### Table 11. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC125A v.7	20130411	Product data sheet	-	74LVC125A v.6
Modifications:	<ul> <li>Features list of</li> </ul>	orrected (errata)		
74LVC125A v.6	20130305	Product data sheet	-	74LVC125A v.5
74LVC125A v.5	20120208	Product data sheet	-	74LVC125A v.4
74LVC125A v.4	20030507	Product specification	-	74LVC125A v.3
74LVC125A v.3	20020308	Product specification	-	74LVC125A v.2
74LVC125A v.2	19980428	Product specification	-	74LVC125A v.1
74LVC125A v.1	19970801	Product specification	-	-

#### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

# 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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### Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

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## Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

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